

Product data sheet

## 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Logic-level compatible
- Leadless ultra small and ultra thin SMD plastic package: 1.1 × 1.0 × 0.37 mm
- Tin-plated 100 % solderable side pads for optical solder inspection •
- ElectroStatic Discharge (ESD) protection > 2 kV HBM
- AEC-Q101 qualified

## 3. Applications

- Relay driver •
- Power management in automotive and industrial applications
- LED driver
- DC-to-DC converter

## 4. Quick reference data

resistance

Symbol	Parameter	Conditions		Min	Тур
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-
V <sub>GS</sub>	gate-source voltage			-20	-
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	-
Static chara	acteristics		·		
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 1.1 A; T <sub>i</sub> = 25 °C		-	345

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.

# nexperia

Max

80

20

1.1

450

Unit

V

V

A

mΩ

## 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		D
2	S	source		
3	D	drain	4 3	G (→ ) (→ )
4	D	drain		
			Transparent top view DFN1010D-3 (SOT1215)	S 017aaa255

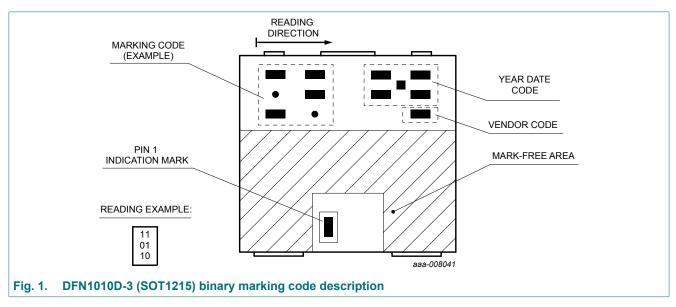
# 6. Ordering information

Table 3. Ordering information						
Type number	Package	age				
	Name	Description	Version			
PMXB360ENEA	DFN1010D-3	DFN1010D-3: plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body 1.1 x 1.0 x 0.37 mm	SOT1215			

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMXB360ENEA	11 10 10



# 8. Limiting values

#### Table 5. Limiting values

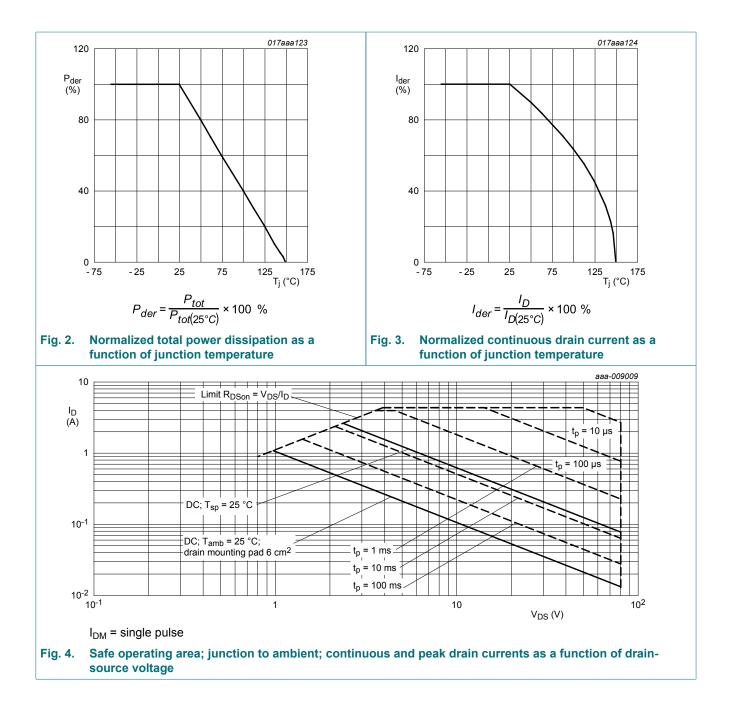
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	80	V
V <sub>GS</sub>	gate-source voltage	_		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	1.1	А
		V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 100 °C	[1]	-	0.7	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	4.4	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	400	mW
			[1]	-	1070	mW
		T <sub>sp</sub> = 25 °C		-	6250	mW
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-drain d	iode			<b>I</b>		
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	0.8	А
ESD maximum	rating	1				
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[3]	-	2000	V
Avalanche rug	gedness					
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$T_{j(init)}$ = 25 °C; I <sub>D</sub> = 0.17 A; DUT in avalanche (unclamped)		-	7.1	mJ

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.
 Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

Measured between all pins. [3]

#### 80 V, N-channel Trench MOSFET



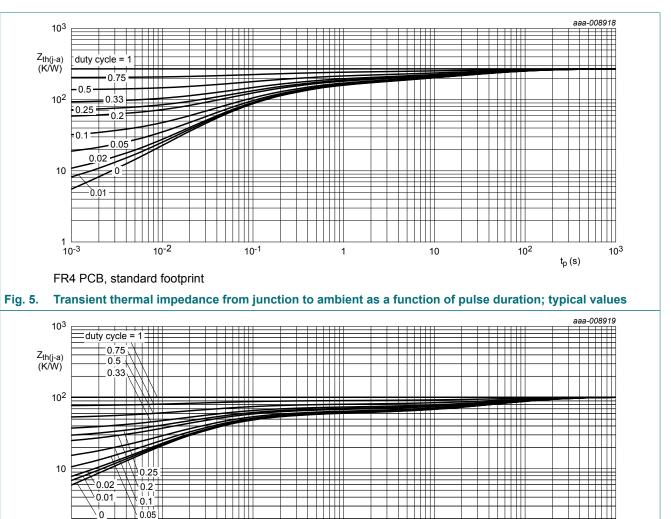
## 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ui(j u)	thermal resistance from junction to ambient	in free air	[1]	-	271	312	K/W
			[2]	-	102	117	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	15	20	K/W

#### Table 6 Thermal characteristics

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.





1

10

10<sup>2</sup>

10-1

10<sup>3</sup>

t<sub>p</sub> (s)

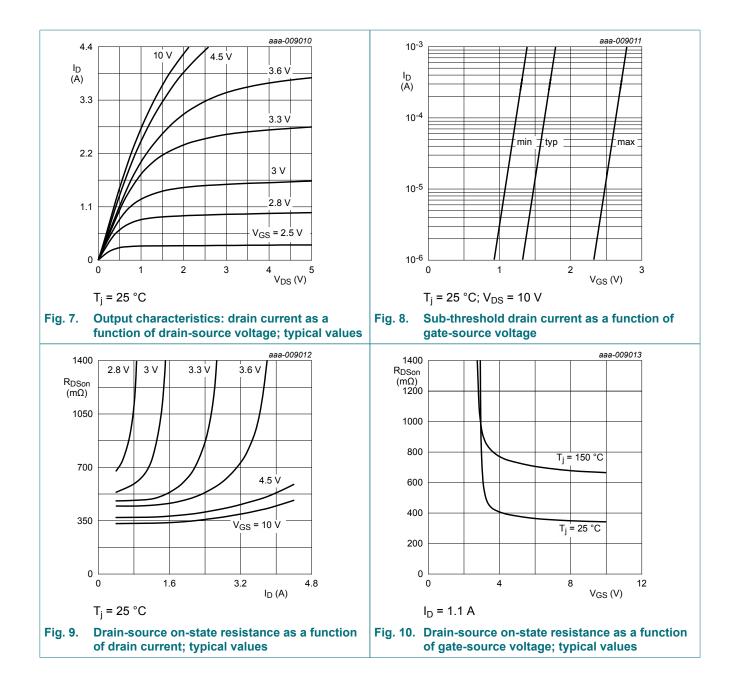
1 └─ 10<sup>-3</sup>

10<sup>-2</sup>

# **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static chara	acteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	80	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	I <sub>D</sub> = 250 μA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C	1.3	1.7	2.7	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 80 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	1	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	15	μA
		$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-15	μA
		V <sub>GS</sub> = 10 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	1	μA
		V <sub>GS</sub> = -10 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-1	μA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 1.1 A; T <sub>j</sub> = 25 °C	-	345	450	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 1.1 A; T <sub>j</sub> = 150 °C	-	660	887	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 1 A; T <sub>j</sub> = 25 °C	-	390	540	mΩ
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 1.1 A; T <sub>j</sub> = 25 °C	-	3.2	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	-	13	-	Ω
Dynamic ch	naracteristics					
Q <sub>G(tot)</sub>	total gate charge	V <sub>DS</sub> = 40 V; I <sub>D</sub> = 1.1 A; V <sub>GS</sub> = 10 V;	-	3	4.5	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	0.4	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.6	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 40 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	130	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	20	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	11	-	pF
t <sub>d(on)</sub>	turn-on delay time	V <sub>DS</sub> = 40 V; I <sub>D</sub> = 1.1 A; V <sub>GS</sub> = 10 V;	-	2	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	3.5	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	9	-	ns
t <sub>f</sub>	fall time		-	3	-	ns
Source-drai	in diode	· · ·				
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 0.8 A; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	0.8	1.2	V

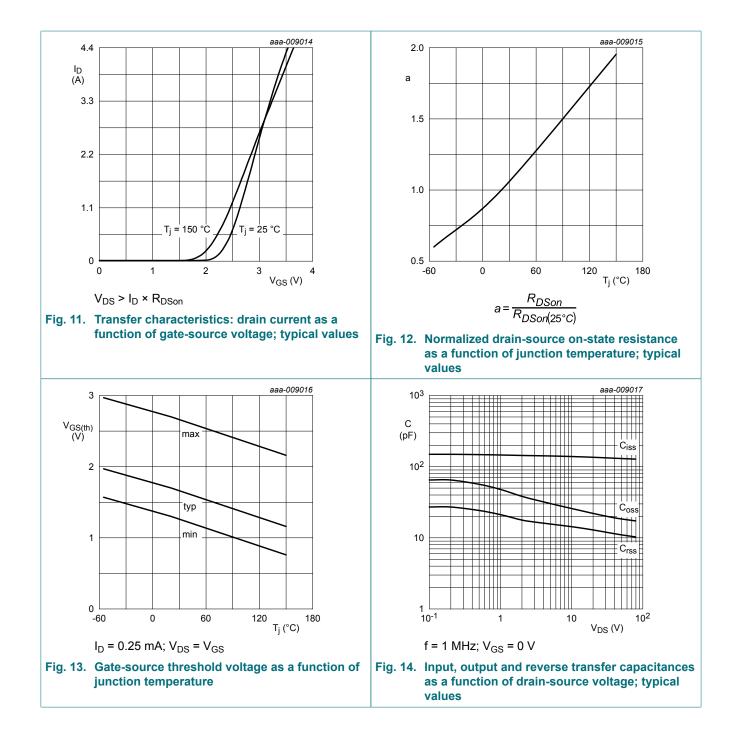
## 80 V, N-channel Trench MOSFET



## Nexperia

# **PMXB360ENEA**

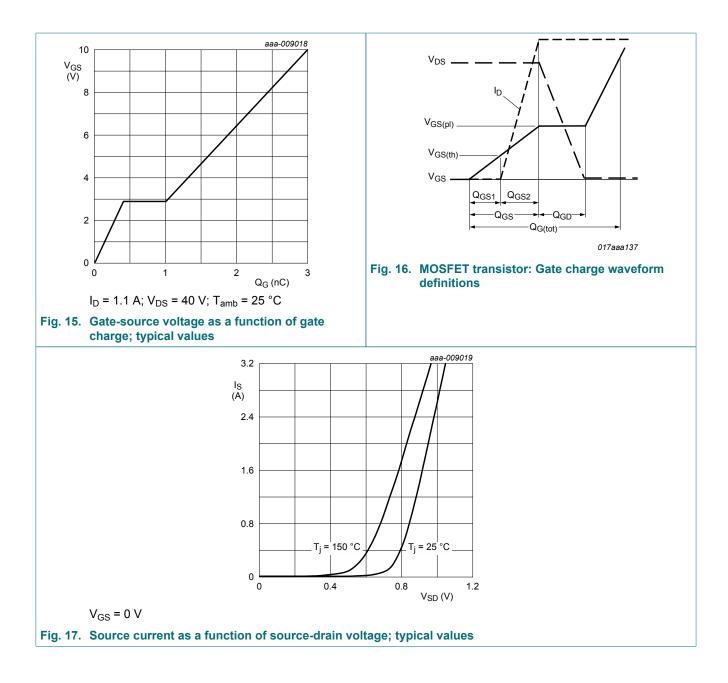
#### 80 V, N-channel Trench MOSFET



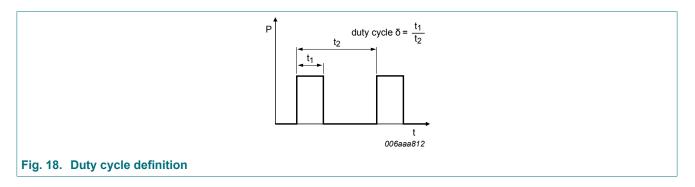
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# **PMXB360ENEA**

80 V, N-channel Trench MOSFET



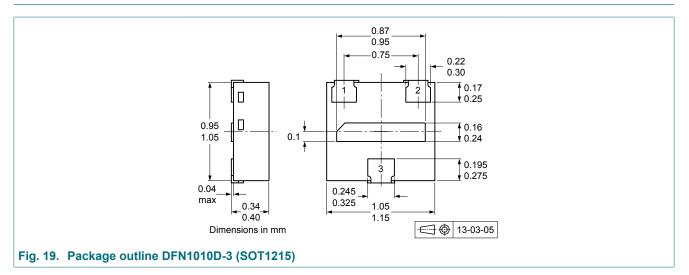
## 11. Test information



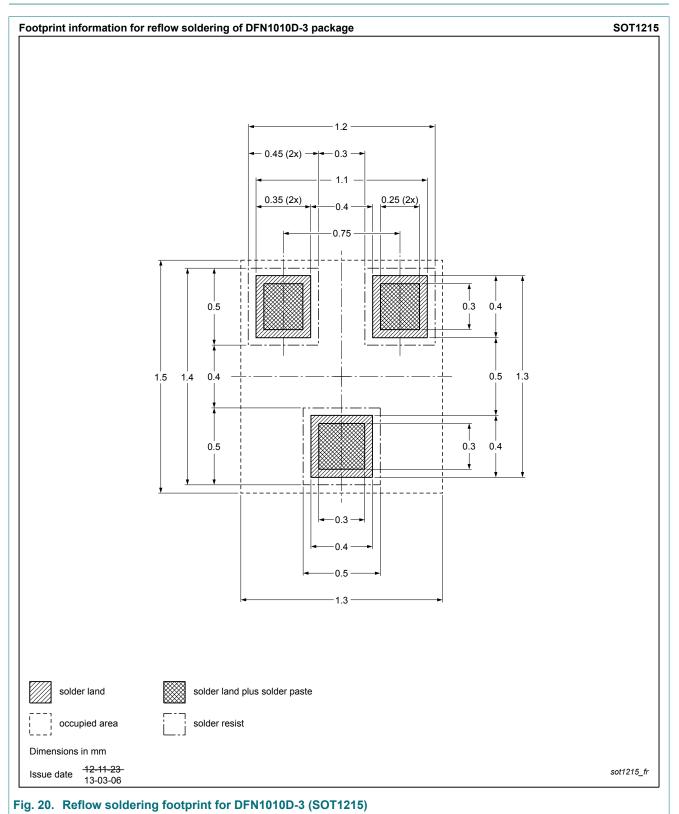
## **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering



# 14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMXB360ENEA v.2	20180705	Product data sheet	-	PMXB360ENEA v.1			
Modification:	- Gate resistance changed to $R_G$ 13 $\Omega$						
PMXB360ENEA v.1	20130916	Product data sheet	-	-			

PMXB360ENEA

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#### 80 V, N-channel Trench MOSFET

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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